

Solder Wave Masking Discs

SWD Series

RoHS & REACH Compliant

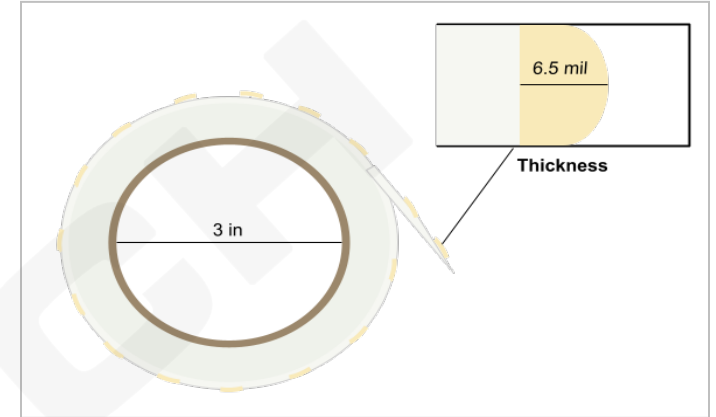
Solder Wave Masking Discs are made from crepe paper with rubber adhesive that can be removed cleanly without leaving any residue. They are ideal for use in wave soldering process to mask sensitive components and high temperature paint operations. They can withstand molten solder for 5-8 seconds at 500° F. These discs may serve as High Temperature Masking Discs.

Applications

- 3D Printing and Aerospace Assembly
- Automotive Facilities and Electronic Assembly
- Fiber Optics Manufacturing and Solar Panels

Product Specifications ⁽¹⁾

Color	Tan	
Adhesion Type	Rubber/Resin	
Total Thickness	6.5 Mil	
Material	Crepe Paper	
Adhesion to Steel	41 oz./in.	
Tensile Strength	22 lbs./in	
Elongation	7.5 %	
Core	3 in. Cardboard Core	
Operating Temperature	1.5 hours @ 300° F 2 hours @ 275° F 3 hours @ 250° F	



⁽¹⁾ Specifications are subject to change at any time. If you have any questions, please contact us for the latest update.

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PRODUCT DATA SHEET